Linear Regulator Dual-Rail, Very Low-Dropout, Programmable Soft-Start

3.0 A

The NCV59749 is dual-rail very low dropout voltage regulator that is capable of providing an output current in excess of 3.0 A with a dropout voltage of 120 mV typ. at full load current. The devices are stable with ceramic and any other type of output capacitor $\ge 2.2 \,\mu\text{F}$. This series contains adjustable output voltage version with output voltage down to 0.8 V. Internal protection features consist of built-in thermal shutdown and output current limiting protection. User-programmable Soft-Start and Power Good pins are available. The NCV59749 is available in QFN20 5x5 package.

Features

- Output Current in Excess of 3.0 A
- V_{IN} Range: 0.8 V to 5.5 V
- V_{BIAS} Range: 2.7 V to 5.5 V
- Output Voltage Range: 0.8 V to 3.6 V
- Dropout Voltage: 120 mV at 3 A
- Programmable Soft Start
- Open Drain Power Good Output
- Fast Transient Response
- Stable with Any Type of Output Capacitor $\ge 2.2 \,\mu\text{F}$
- Current Limit and Thermal Shutdown Protection
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable
- These are Pb–Free Devices

Applications

- Automotive, Consumer and Industrial Equipment Point of Load Regulation
- FPGA, DSP and Logic Power Supplies
- Switching Power Supply Post Regulation

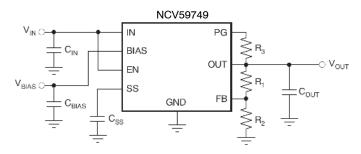


Figure 1. Typical Application Schematic



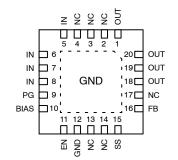
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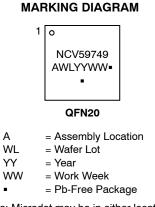


CASE 485DB

PIN CONNECTIONS



QFN20, 5x5, 0.65P



(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 9 of this data sheet.

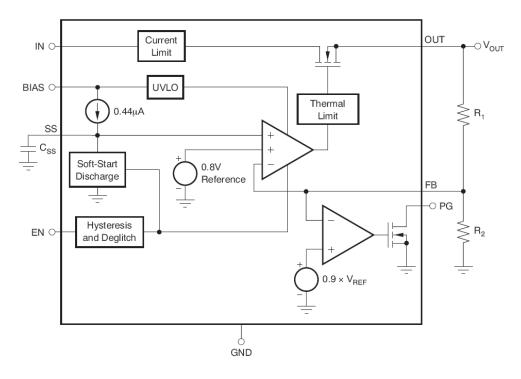


Figure 2. Simplified Schematic Block Diagram

Table 1. PIN FUNCTION DESCRIPTION

Name	QFN20	Description
IN	5–8	Unregulated input to the device.
EN	11	Enable pin. Driving this pin high enables the regulator. Driving this pin low puts the regulator into shutdown mode. This pin must not be left floating.
SS	15	Soft-Start pin. A capacitor connected on this pin to ground sets the start-up time. If this pin is left floating, the regulator output soft-start ramp time is typically 200 μ s.
BIAS	10	Bias input voltage for error amplifier, reference, and internal control circuits.
PG	9	Power-Good (PG) is an open-drain, active-high output that indicates the status of V _{OUT} . When V _{OUT} exceeds the PG trip threshold, the PG pin goes into a high-impedance state. When V _{OUT} is below this threshold the pin is driven to a low-impedance state. A pull-up resistor from 10 k Ω to 1 M Ω should be connected from this pin to a supply up to 5.5 V. The supply can be higher than the input voltage. Alternatively, the PG pin can be left floating if output monitoring is not necessary.
FB	16	This pin is the feedback connection to the center tap of an external resistor divider network that sets the output voltage. This pin must not be left floating.
OUT	1, 18–20	Regulated output voltage. A small capacitor (total typical capacitance \ge 2.2 μ F, ceramic) is needed from this pin to ground to assure stability.
NC	2–4, 13, 14, 17	No connection. This pin can be left floating or connected to GND to allow better thermal contact to the top-side plane.
GND	12	Ground
PAD/TAB		Should be soldered to the ground plane for increased thermal performance

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Input Voltage Range	V _{IN}	-0.3 to +6	V
Input Voltage Range	V _{BIAS}	-0.3 to +6	V
Enable Voltage Range	V _{EN}	-0.3 to +6	V
Power-Good Voltage Range	V _{PG}	-0.3 to +6	V
PG Sink Current	I _{PG}	0 to +1.5	mA
SS Pin Voltage Range	V _{SS}	-0.3 to +6	V
Feedback Pin Voltage Range	V _{FB}	-0.3 to +6	V
Output Voltage Range	V _{OUT}	-0.3 to (V _{IN} + 0.3) ≤ 6	V
Maximum Output Current	I _{OUT}	Internally Limited	
Output Short Circuit Duration		Indefinite	
Continuous Total Power Dissipation	PD	See Thermal Characteristics Table and Formula	
Maximum Junction Temperature	T _{JMAX}	+125	°C
Storage Junction Temperature Range	T _{STG}	–55 to +150	°C
ESD Capability, Human Body Model (Note 2)	ESD _{HBM}	2000	V
ESD Capability, Machine Model (Note 2)	ESD _{MM}	200	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

2. This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per AEC-Q100-002.

ESD Machine Model tested per AEC-Q100-003.

Latch-up Current Maximum Rating \leq 150 mA per AEC-Q100-004.

Table 3. THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Characteristics, QFN20, 5x5, 0.65P package			
Thermal Resistance, Junction-to-Ambient (Note 5)	$R_{ hetaJA}$	30.5	°C/W
Thermal Resistance, Junction-to-Case (bottom) (Note 6)	$R_{ hetaJC}$	4.1	°C/W

3. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

4. Thermal data are derived by thermal simulations based on methodology specified in the JEDEC JESD51 series standards. The following assumptions are used in the simulations:

- This data was generated with only a single device at the center of a high-K (2s2p) board with 3 in x 3 in copper area which follows the JEDEC51.7 guidelines.

- The exposed pad is connected to the PCB ground layer through a 4x4 thermal via array. Vias are 0.3 mm diameter, plated.

- Each of top and bottom copper layers has a dedicated pattern for 20% copper coverage.

5. The junction-to-ambient thermal resistance under natural convection is obtained in a simulation on a high-K board, following the JEDEC51.7 guidelines with assumptions as above, in an environment described in JESD51-2a.

6. The junction-to-case (bottom) thermal resistance is obtained by simulating a cold plate test on the IC exposed pad. Test description can be found in the ANSI SEMI standard G30-88.

Table 4. RECOMMENDED OPERATING CONDITIONS (Note 7)

Rating	Symbol	Min	Мах	Unit
Input Voltage	V _{IN}	V _{OUT} + V _{DO}	5.5	V
Bias Voltage	V _{BIAS}	2.7	5.5	V
Junction Temperature	TJ	-40	125	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

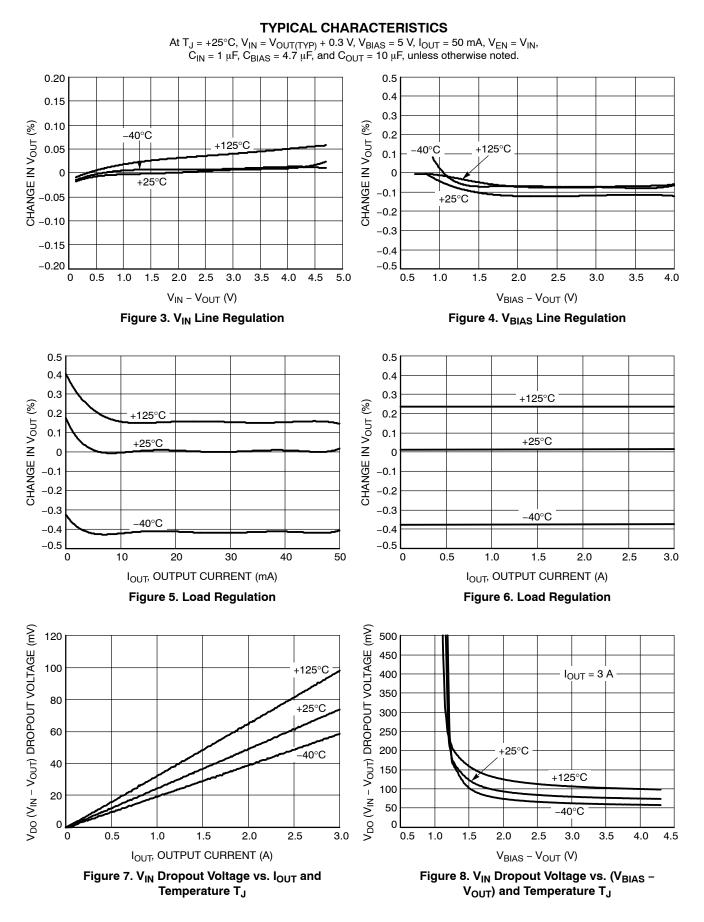
7. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

Table 5. ELECTRICAL CHARACTERISTICS (At $V_{EN} = 1.1 \text{ V}$, $V_{IN} = V_{OUT} + 0.3 \text{ V}$, $C_{BIAS} = 0.1 \mu\text{F}$, $C_{SS} = 1 \text{ nF}$, $C_{IN} = C_{OUT} = 10 \mu\text{F}$, $I_{OUT} = 50 \text{ mA}$, $V_{BIAS} = 5.0 \text{ V}$, $T_J = -40^{\circ}\text{C}$ to +125°C, unless otherwise noted. Typical values are at $T_J = +25^{\circ}\text{C}$.)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
VIN	Input Voltage Range		V _{OUT} +V _{DO}		5.5	V
V _{BIAS}	Bias Pin Voltage Range		2.7		5.5	V
UVLO	Undervoltage Lock-out	V _{BIAS} rising Hysteresis	1.2	1.6 0.4	1.9	V
V _{REF}	Internal Reference (Adj.)	$T_J = +25^{\circ}C$	0.798	0.802	0.806	V
V _{OUT}	Output Voltage Range	V _{IN} = 5 V, I _{OUT} = 3.0 A	V _{REF}		3.6	V
	Accuracy (Note 1)	V _{OUT} + 2.2 V < V _{BIAS} < 5.5 V, 50 mA < I _{OUT} < 3.0 A	- 2	±0.5	+ 2	%
V _{OUT} /V _{IN}	Line Regulation	V _{OUT (NOM)} + 0.3 < V _{IN} < 5.5 V		0.03		%/V
V _{OUT} /I _{OUT}	Load Regulation	50mA < I _{OUT} < 3.0 A		0.09		%/A
V_{DO}	V _{IN} Dropout Voltage (Note 2)	$ I_{OUT} = 3.0 \text{ A}, \\ V_{BIAS} - V_{OUT (NOM)} \ge 3.25 \text{ V} (\text{Note 3}) $		120	280	mV
	V _{BIAS} Dropout Voltage (Note 2)	I_{OUT} = 3.0 A, V_{IN} = V_{BIAS}		1.31	1.75	V
I _{CL}	Current Limit	V _{OUT} = 80% x V _{OUT (NOM)}	3.5	4.6	7.0	А
I _{BIAS}	Bias Pin Current			1	2	mA
I _{SHDN}	Shutdown Supply Current (I _{GND})	$V_{EN} \le 0.4 V$		1	50	μA
I _{FB}	Feedback Pin Current		- 1	0.15	1	μA
PSRR	Power-supply Rejection (V _{IN} to V _{OUT})	1 kHz, I _{OUT} = 1.5 A, V _{IN} = 1.8 V, V _{OUT} = 1.5 V		60		dB
		300 kHz, I_{OUT} = 1.5 A, V_{IN} = 1.8 V, V_{OUT} = 1.5 V		30]
	Power-supply Rejection (V _{BIAS} to V _{OUT})	1 kHz, I _{OUT} = 1.5 A, V _{IN} = 1.8 V, V _{OUT} = 1.5 V		50		dB
		300 kHz, I_{OUT} = 1.5 A, V_{IN} = 1.8 V, V_{OUT} = 1.5 V		30]
Noise	Output Noise Voltage	100 Hz to 100 kHz, I _{OUT} = 3 A		25 x V _{OUT}		μV_{RMS}
t _{STRT}	Minimum Startup Time	R_{LOAD} for I_{OUT} = 1.0 A, C_{SS} = open		200		μs
I _{SS}	Soft-start Charging Current	V _{SS} = 0.4 V		0.44		μA
V _{EN, HI}	Enable Input High Level		1.1		5.5	V
V _{EN, LO}	Enable Input Low Level		0		0.4	V
V _{EN, HYS}	Enable Pin Hysteresis			50		mV
V _{EN, DG}	Enable Pin Deglitch Time			20		μs
I _{EN}	Enable Pin Current	V _{EN} = 5 V		0.1	1	μA
V _{IT}	PG Trip Threshold	V _{OUT} decreasing	85	90	94	%V _{OUT}
V _{HYS}	PG Trip Hysteresis			3		%V _{OUT}
V _{PG, LO}	PG Output Low Voltage	I_{PG} = 1 mA (Sinking), $V_{OUT} < V_{IT}$			0.3	V
I _{PG, LKG}	PG Leakage Current	V _{PG} = 5.25 V, V _{OUT} > V _{IT}		0.1	1	μA
TSD	Thermal Shutdown Temperature	Shutdown, temperature increasing Reset, temperature decreasing		+165 +140		°C

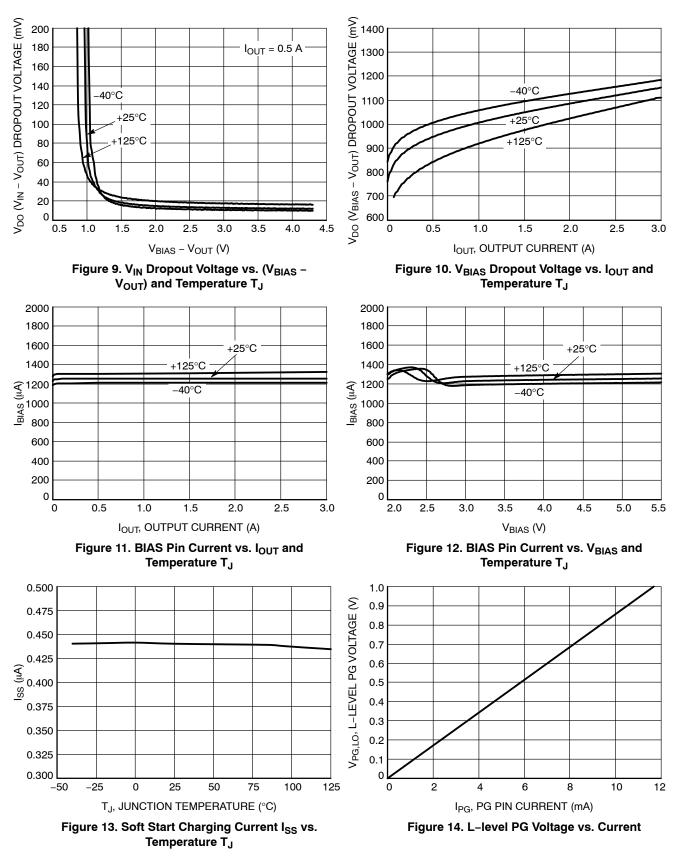
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Adjustable devices tested at V_{REF} ; external resistor tolerance is not taken into account. 2. Dropout is defined as the voltage from the input to V_{OUT} when V_{OUT} is 3% below nominal. 3. 3.25 V is a test condition of this device and can be adjusted by referring to Figure 8.



TYPICAL CHARACTERISTICS

At T_J = +25°C, V_{IN} = V_{OUT(TYP)} + 0.3 V, V_{BIAS} = 5 V, I_{OUT} = 50 mA, V_{EN} = V_{IN}, C_{IN} = 1 μ F, C_{BIAS} = 4.7 μ F, and C_{OUT} = 10 μ F, unless otherwise noted.



TYPICAL CHARACTERISTICS

At T_J = +25°C, V_{IN} = V_{OUT(TYP)} + 0.3 V, V_{BIAS} = 5 V, I_{OUT} = 50 mA, V_{EN} = V_{IN}, C_{IN} = 1 μ F, C_{BIAS} = 4.7 μ F, and C_{OUT} = 10 μ F, unless otherwise noted.

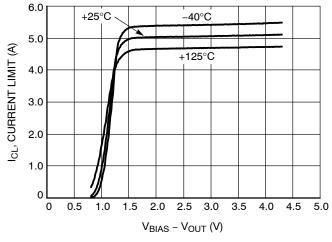


Figure 15. Current Limit vs. (V_{BIAS} – V_{OUT})

APPLICATIONS INFORMATION

The NCV59749 dual-rail very low dropout voltage regulator is using NMOS pass transistor for output voltage regulation from V_{IN} voltage. All the low current internal controll circuitry is powered from the V_{BIAS} voltage.

The use of an NMOS pass transistor offers several advantages in applications. Unlike a PMOS topology devices, the output capacitor has reduced impact on loop stability. Vin to Vout operating voltage difference can be very low compared with standard PMOS regulators in very low Vin applications.

The NCV59749 offers programmable smooth monotonic start-up. The controlled voltage rising limits the inrush current what is advantageous in applications with large capacitive loads. The Voltage Controlled Soft Start timing is programmable by external Css capacitor value.

The Enable (EN) input is equipped with internal hysteresis and deglitch filter.

Open Drain type Power Good (PG) output is available for Vout monitoring and sequencing of other devices.

NCV59749 is a Adjustable linear regulator. The required Output voltage can be adjusted by two external resistors. Typical application schematics is shown in Figure 16.

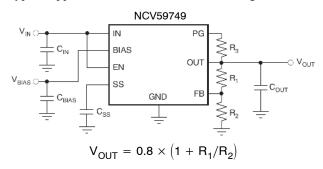


Figure 16. Typical Application Schematics

Dropout Voltage

Because of two power supply inputs V_{IN} and V_{BIAS} and one V_{OUT} regulator output, there are two Dropout voltages specified.

The first, the V_{IN} Dropout voltage is the voltage difference ($V_{IN} - V_{OUT}$) when V_{OUT} starts to decrease by percents specified in the Electrical Characteristics table. V_{BIAS} is high enough, specific value is published in the Electrical Characteristics table.

The second, V_{BIAS} dropout voltage is the voltage difference ($V_{BIAS} - V_{OUT}$) when V_{IN} and V_{BIAS} pins are joined together and V_{OUT} starts to decrease.

Input and Output Capacitors

The device is designed to be stable for all available types and values of output capacitors $\geq 2.2 \ \mu\text{F}$. The device is also stable with multiple capacitors in parallel, which can be of any type or value.

In applications where no low input supplies impedance available (PCB inductance in V_{IN} and/or V_{BIAS} inputs as

example), the recommended C_{IN} and C_{BIAS} value is 1 μ F or greater. Ceramic or other low ESR capacitors are recommended. For the best performance all the capacitors should be connected to the NCV59749 respective pins directly in the device PCB copper layer, not through vias having not negligible impedance.

Enable Operation

The enable pin will turn the regulator on or off. The threshold limits are covered in the electrical characteristics table in this data sheet. If the enable function is not to be used then the pin should be connected to V_{IN} or V_{BIAS} .

Output Noise

When the NCV59749 device reaches the end of the Soft–Start cycle, the Soft Start capacitor is switched to serve as a Noise filtering capacitor.

Output Voltage Adjust

The output voltage can be adjusted from 0.8 V to 3.6 V using resistors divider between the output and the FB input. Recommended resistor values for frequently used voltages can be found in the Table 6.

Programmable Soft-Start

The Soft-Start ramp time depends on the Soft Start charging current I_{SS} , Soft-Start capacitor value C_{SS} and internal reference voltage V_{REF} .

The Soft –Start time can be calculated using following equations:

 $t_{ss} = C_{SS} x (V_{REF} / I_{SS}) [s, F, V, A]$

or in more practical units

 $t_{SS} = C_{SS} \ge 0.8 V / 0.44 = C_{SS} \ge 1.82$

where

 $t_{ss} = Soft-Start time in miliseconds$

 $C_{SS} = Soft-Start$ capacitor value in nano Farads

Capacitor values for frequently used Soft-Start times can be found in the Table 7.

The maximal recommended value of C_{SS} capacitor is 15 nF. For higher C_{SS} values the capacitor full discharging before new Soft-Start cycle is not guaranteed.

Current Limitation

The internal Current Limitation circuitry allows the device to supply the full nominal current and surges but protects the device against Current Overload or Short.

Thermal Protection

Internal thermal shutdown (TSD) circuitry is provided to protect the integrated circuit in the event that the maximum junction temperature is exceeded. When TSD activated, the regulator output turns off. When cooling down under the low temperature threshold, device output is activated again. This TSD feature is provided to prevent failures from accidental overheating.

Power Dissipation

The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and the ambient temperature affect the rate of junction temperature rise for the part. For reliable operation junction temperature should be limited to $+125^{\circ}$ C.

Table 6. RESISTOR VALUES FOR PROGRAMMING THE OUTPUT VOLTAGE

V _{OUT} (V)	R ₁ (kΩ)	R ₂ (kΩ)
0.8	Short	Open
0.9	0.619	4.99
1.0	1.13	4.53
1.05	1.37	4.33
1.1	1.87	4.99
1.2	2.49	4.99
1.5	4.12	4.75
1.8	3.57	2.87
2.5	3.57	1.69
3.3	3.57	1.15

NOTE: $V_{OUT} = 0.8 \times (1 + R_1/R_2)$ Resistors in the table are standard 1% types

Table 8.	ORDERING INFORMATION

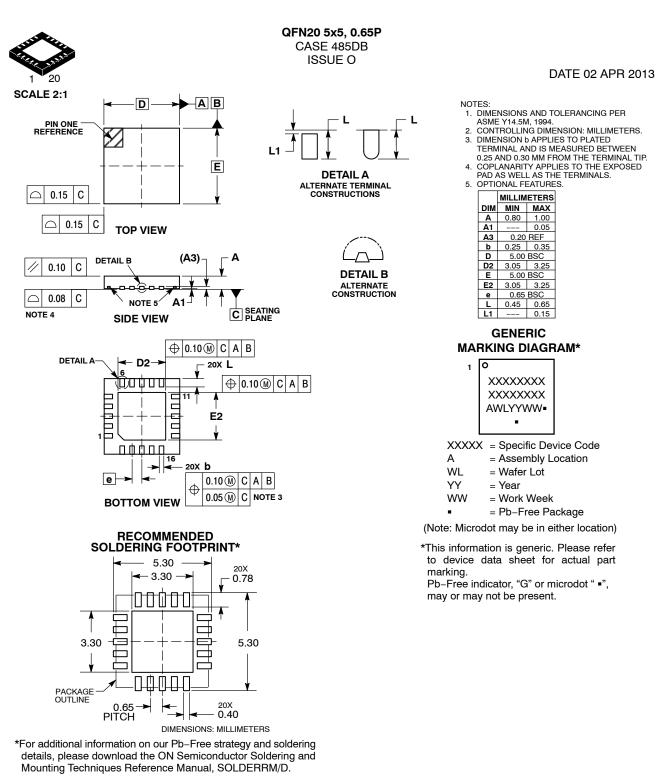
Device	Output Current	Output Voltage	Junction Temp. Range	Package	Shipping
NCV59749MNADJTBG	3.0 A	ADJ	–40°C to +125°C	QFN20 (Pb-Free)	3000 / Tape & Reel

Table 7. CAPACITOR VALUES FOR PROGRAMMING THE SOFT-START TIME

Soft-Start Time	C _{SS}
0.2 ms	Open
0.5 ms	270 pF
1 ms	560 pF
5 ms	2.7 nF
10 ms	5.6 nF
18 ms	10 nF

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





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